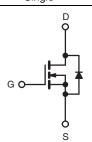


### **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	200				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	0.80			
Q <sub>g</sub> (Max.) (nC)	14				
Q <sub>gs</sub> (nC)	3.0				
Q <sub>gd</sub> (nC)	7.9				
Configuration	Sinc	Single			





N-Channel MOSFET

#### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- · Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION			
Package	HVMDIP		
Lead (Pb)-free	IRFD220PbF		
Lead (FD)-life	SiHFD220-E3		
SnPb	IRFD220		
OIII D	SiHFD220		

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C, unless otherwise parameter			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	200		
Gate-Source Voltage			V <sub>GS</sub>	± 20	V	
Continuous Drain Current	V at 10 V	T <sub>A</sub> = 25 °C	I <sub>D</sub>	0.80	А	
Continuous Drain Gurrent	V <sub>GS</sub> at 10 V	T <sub>A</sub> = 100 °C		0.50		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	6.4	1	
Linear Derating Factor				0.0083	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	260	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	5.2	А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	0.10	mJ	
Maximum Power Dissipation	n Power Dissipation T <sub>A</sub> = 25 °C		P <sub>D</sub>	1.0	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	5.0	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	- °C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>		

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 152 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 1.6 A (see fig. 12).
- c.  $I_{SD} \leq 5.2$  A,  $dI/dt \leq 95$  A/µs,  $V_{DD} \leq V_{DS},\, T_{J} \leq 150$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRFD220, SiHFD220

# Vishay Siliconix



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	$R_{thJA}$	-	120	°C/W	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	$V_{DS}$	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		200	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I <sub>D</sub> = 1 mA		0.29	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Zone Code Welters Dusin Comment	I <sub>DSS</sub>	V <sub>DS</sub> =	V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V		-	25	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 160 V	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 0.48 A <sup>b</sup>	-	-	0.80	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 0.48 A <sup>b</sup>		0.60	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		-	260	-	pF
Output Capacitance	Coss			-	100	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	.0 MHz, see fig. 5	-	30	-	
Total Gate Charge	Qg			-	-	14	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 4.8 \text{ A}, V_{DS} = 160 \text{ V},$ see fig.6 and 13 <sup>b</sup>		-	3.0	nC
Gate-Drain Charge	Q <sub>gd</sub>	1	occ fig.o and fo	-	-	7.9	1
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = 100 \text{ V, } I_D = 4.8 \text{ A,} \\ R_g = 18 \ \Omega, \ R_D = 19 \ \Omega, \\ \text{see fig. } 10^b$		-	7.2	-	ns
Rise Time	t <sub>r</sub>			-	22	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	19	-	
Fall Time	t <sub>f</sub>			-	13	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-	nЦ
Internal Source Inductance	L <sub>S</sub>			-	6.0	-	- nH
Drain-Source Body Diode Characteristic	s	•					
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	0.80	A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	6.4	A
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C	I <sub>S</sub> = 0.80 A, V <sub>GS</sub> = 0 V <sup>b</sup>	-	-	1.8	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T _ 05 °C !	_ 4.9.4. dl/dt = 100.4/h	-	150	300	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25  ^{\circ}\text{C}, I_F = 4.8  \text{A},  \text{dI/dt} = 100  \text{A/} \mu \text{s}^{\text{b}}$		-	0.91	1.8	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	rn-on time is negligible (turn	on is dor	ninated b	y L <sub>S</sub> and	L <sub>D</sub> )

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%$



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

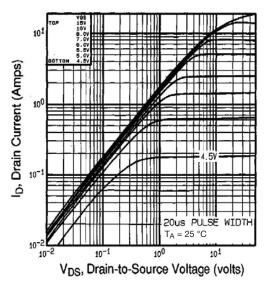


Fig. 1 - Typical Output Characteristics, T<sub>A</sub> = 25 °C

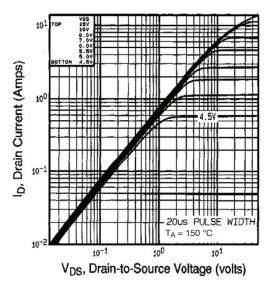
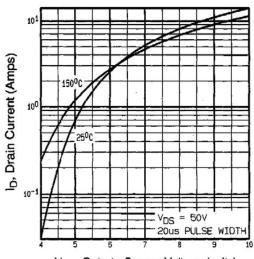


Fig. 2 - Typical Output Characteristics,  $T_A$  = 150 °C



V<sub>GS</sub>, Gate-to-Source Voltage (volts)

Fig. 3 - Typical Transfer Characteristics

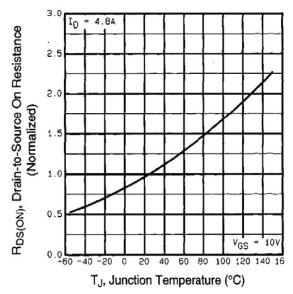


Fig. 4 - Normalized On-Resistance vs. Temperature



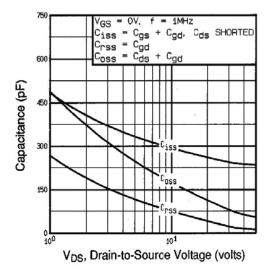


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

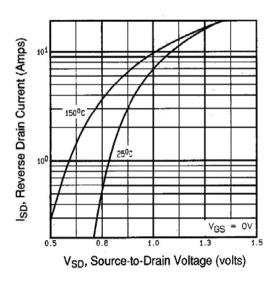


Fig. 7 - Typical Source-Drain Diode Forward Voltage

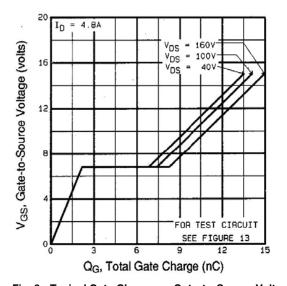


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

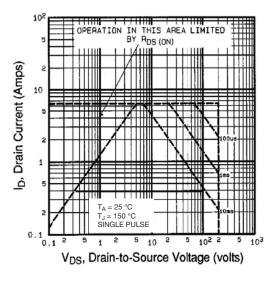


Fig. 8 - Maximum Safe Operating Area





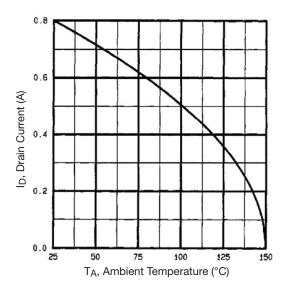


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

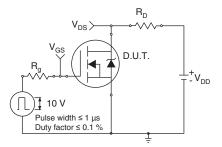


Fig. 10a - Switching Time Test Circuit

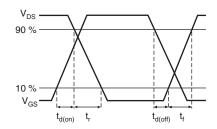


Fig. 10b - Switching Time Waveforms

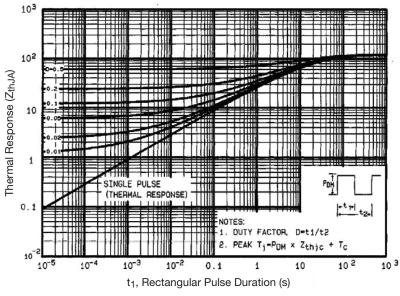


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



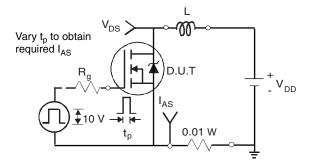


Fig. 12a - Unclamped Inductive Test Circuit

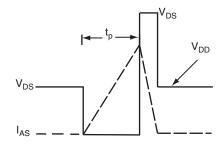


Fig. 12b - Unclamped Inductive Waveforms

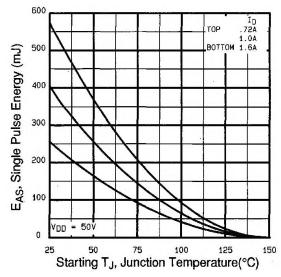


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

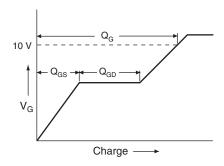


Fig. 13a - Basic Gate Charge Waveform

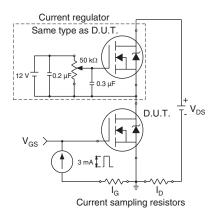
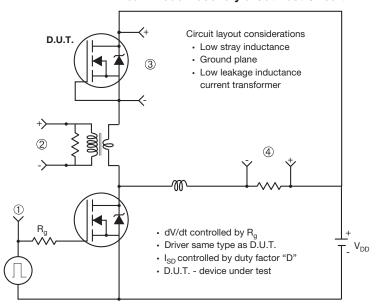


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



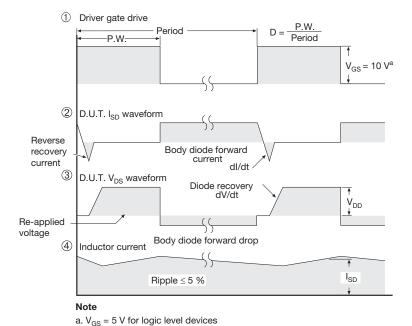
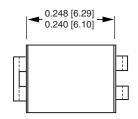
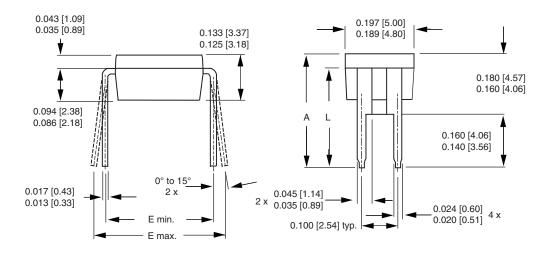


Fig. 14 - For N-Channel

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### **HVM DIP** (High voltage)





	INCHES		MILLIMETERS		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	0.310	0.330	7.87	8.38	
E	0.300	0.425	7.62	10.79	
L	0.270	0.290	6.86	7.36	

ECN: X10-0386-Rev. B, 06-Sep-10

DWG: 5974

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.

Document Number: 91361 Revision: 06-Sep-10



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